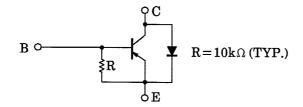
TOSHIBA Transistor Silicon NPN Epitaxial Type (PCT Process)

RN6006

Motor Drive Circuit Applications
Power Amplifier Applications
Power Switching Applications

- With built-in bias resistors
- Simplify circuit design
- Reduce a quantity of parts and manufacturing process
- Small flat package
- $PC = 1\sim 2W$ (mounted on ceramic substrate)
- Complementary to RN5006

Equivalent Circuit



Maximum Ratings (Ta = 25°C)

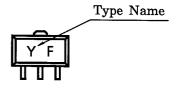
Characteristic		Symbol	Rating	Unit	
Collector-base voltage		V_{CBO}	-10	٧	
Collector-emitter voltage		V_{CEO}	-10	٧	
Emitter-base voltage		V _{EBO}	-6	٧	
Collector current	DC	IC	-2	А	
	Pulse (Note1)	I _{CP}	-4		
Base current		ΙΒ	-0.4	Α	
Collector power dissipation		P_{C}	500	mW	
Collector power dissipation		P _C *	1000	mW	
Junction temperature		Tj	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

Note: Pulse width ≤ 10 ms, duty cycle ≤ 30 %

		Unit: mm					
$0.45 - 0.0$ $0.45 - 0.0$ $0.4 - 0.05$ 1.5 ± 0.1	3	1,6MAX. 0.4±0.05 10+20 10+2					
 BASE COLLECTOR (HEAT SINK) EMITTER 							
PW-M	INI						
JEDEC							
JEITA		SC-62					
TOSHIBA	2 05g (tup.)	2-5K1A					

Weight: 0.05g (typ.)

Marking



^{* :} Mounterd on ceramic substrate (250mm² × 0.8t)

Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Collector cut-offcurrent	I _{CBO}	_	$V_{CB} = -10V, I_E = 0$	_	_	-0.1	μΑ
Emitter cut-off current	I _{EBO}	_	V _{EB} = -6V, I _C = 0	-0.462	-0.60	-0.857	mA
Collector-emitter breakdown voltage	V _{(BR)CES}	_	I _C = −1mA	-10	-	_	V
DC current gain	h _{FE (1)}		$V_{CE} = -1V$, $I_{C} = -0.5A$	160	_	600	
	h _{FE (2)}	V _{CE} = −1V, IC = −4.0A	60	_	_	_	
Collector-emitter saturation voltage	V _{CE (sat)}	_	$I_C = -2A$, $I_B = -0.05A$	_	_	-0.5	V
Transition frequency	f _T	_	$V_{CE} = -1V$, $I_{C} = -0.5A$	_	140	_	MHz
Collector output capacitance	C _{ob}	_	V _{CB} = −10V, I _E = 0, f = 1 MHz	_	55	_	pF
Resistor	R	_	_	7	10	13	kΩ

2 2001-10-29

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000707EAA

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